SN54ALS157A, SN54ALS158 SN74ALS157A, SN74ALS158, SN74AS157, SN74AS158 QUADRUPLE 1-OF-2 DATA SELECTORS/MULTIPLEXERS

SDAS081C - APRIL 1982 - REVISED DECEMBER 1994

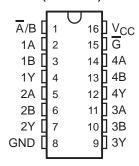
- Buffered Inputs and Outputs
- Package Options Include Plastic Small-Outline (D) Packages, Ceramic Chip Carriers (FK), and Standard Plastic (N) and Ceramic (J) 300-mil DIPs

description

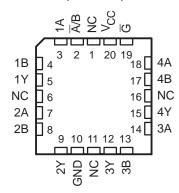
These data selectors/multiplexers contain inverters and drivers to supply full data selection to the four output gates. A separate strobe (\overline{G}) input is provided. A 4-bit word is selected from one of two sources and is routed to the four outputs. The 'ALS157A and SN74AS157 present true data. The 'ALS158 and SN74AS158 present inverted data to minimize propagation delay time.

The SN54ALS157A and SN54ALS158 are characterized for operation over the full military temperature range of -55°C to 125°C. The SN74ALS157A, SN74ALS158, SN74AS157, and SN74AS158 are characterized for operation from 0°C to 70°C.

SN54ALS157A, SN54ALS158 . . . J PACKAGE SN74ALS157A, SN74ALS158, SN74AS157, SN74AS158 . . . D OR N PACKAGE (TOP VIEW)



SN54ALS157A, SN54ALS158 . . . FK PACKAGE (TOP VIEW)



NC - No internal connection

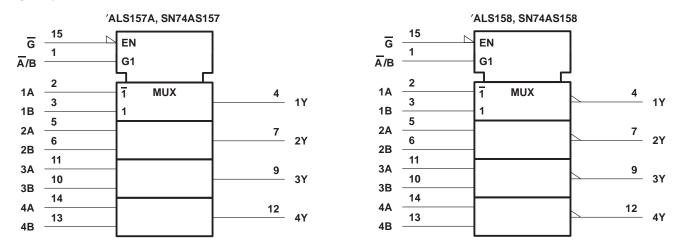
FUNCTION TABLE

	INP	JTS		OUTF	PUT Y
G	A/B	DA	TΑ	'ALS157A	'ALS158
G	A/B	Α	В	SN74AS157	SN74AS158
Н	Χ	Х	Х	L	Н
L	L	L	Χ	L	Н
L	L	Н	Χ	Н	L
L	Н	Х	L	L	Н
L	Н	Х	Н	Н	L

SN54ALS157A, SN54ALS158 SN74ALS157A, SN74ALS158, SN74AS157, SN74AS158 QUAD 1-OF-2 DATA SELECTORS/MULTIPLEXERS

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logic symbols†

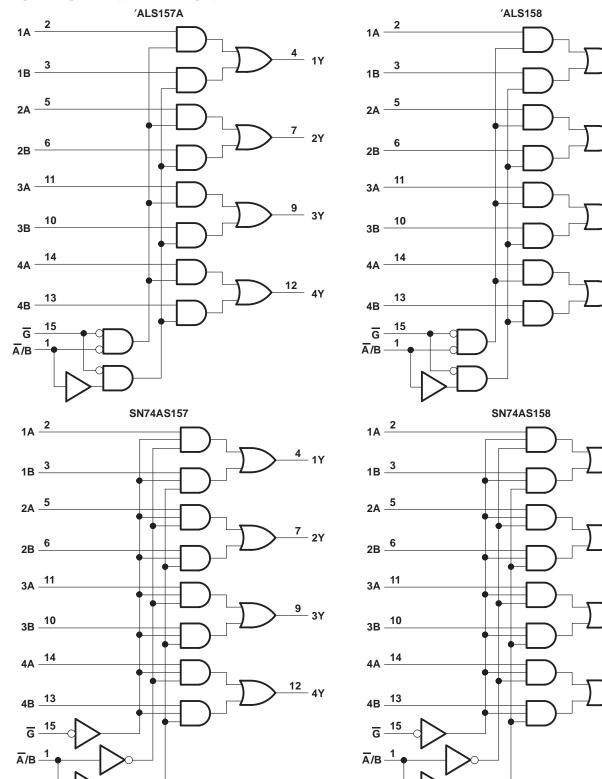


 $[\]dagger$ These symbols are in accordance with ANSI/IEEE Std 91-1984 and IEC Publication 617-12. Pin numbers shown are for the D, J, and N packages.

7 2Y

9 3Y

logic diagrams (positive logic)



Pin numbers shown are for the D, J, and N packages.



12 4Y

SN54ALS157A, SN54ALS158 SN74ALS157A, SN74ALS158, SN74AS157, SN74AS158 QUAD 1-OF-2 DATA SELECTORS/MULTIPLEXERS

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absolute maximum ratings over operating free-air temperature range (unless otherwise noted)†

Supply voltage, V _{CC}		 7 V
Input voltage, V _I		 7 V
Operating free-air temperature range, T _A :		
	SN74ALS157A, SN74ALS158	
Storage temperature range		_65°C to 150°C

recommended operating conditions

			54ALS15 54ALS1		SN74ALS157A SN74ALS158			UNIT
		MIN	NOM	MAX	MIN	NOM	MAX	
VCC	Supply voltage	4.5	5	5.5	4.5	5	5.5	V
VIH	High-level input voltage	2			2			V
V _{IL}	Low-level input voltage			0.7			0.8	V
IOH	High-level output current			-0.4			-0.4	mA
loL	Low-level output current			4			8	mA
TA	Operating free-air temperature	-55		125	0		70	°C

electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

PA	RAMETER	TEST CO	ONDITIONS		SN54ALS157A SN54ALS158			SN74ALS157A SN74ALS158			
				MIN	TYP‡	MAX	MIN	TYP [‡]	MAX		
VIK		V _{CC} = 4.5 V,	$I_{I} = -18 \text{ mA}$			-1.2			-1.2	V	
Vон		$V_{CC} = 4.5 \text{ V to } 5.5 \text{ V},$	$I_{OH} = -0.4 \text{ mA}$	VCC -	2		VCC -2)		V	
V		\\ 45\\	I _{OL} = 4 mA		0.25	0.4		0.25	0.4	0.4 0.5	
VOL		V _{CC} = 4.5 V	I _{OL} = 8 mA					0.35	0.5		
Ц		$V_{CC} = 5.5 \text{ V},$	V _I = 7 V			0.1			0.1	mA	
lіН		$V_{CC} = 5.5 \text{ V},$	V _I = 2.7 V			20			20	μΑ	
I∣∟		V _{CC} = 5.5 V,	V _I = 0.4 V			-0.1			-0.1	mA	
IO§		V _{CC} = 5.5 V,	V _O = 2.25 V	-20		-112	-30		-112	mA	
la a	'ALS157A	Vac EEV	See Note 1		6	11		6	11	A	
ICC	'ALS158	V _{CC} = 5.5 V,	See Note 1		5	10		5	10	mA	

[‡] All typical values are at V_{CC} = 5 V, T_A = 25°C.

[†] Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

[§] The output conditions have been chosen to produce a current that closely approximates one half of the true short-circuit output current, I_{OS}. NOTE 1: I_{CC} is measured with 4.5 V applied to all inputs and all outputs open.

switching characteristics (see Figure 1)

PARAMETER	FROM (INPUT)	то	$V_{CC} = 5 \text{ V},$ $C_L = 50 \text{ pF},$ $R_L = 500 \Omega,$ $T_A = 25^{\circ}\text{C}$	V _{CC} = 4.5 V to 5.5 V, C _L = 50 pF, R _L = 500 Ω , T _A = MIN to MAX \dagger			,	UNIT
	, ,		'ALS157A	SN54ALS157A		SN74ALS157A		
			TYP	MIN	MAX	MIN	MAX	
^t PLH	A B	V	9	4	17	4	14	
t _{PHL}	A or B	Y	6	2	15	2	12	ns
^t PLH	Ā/B	V	15	7	28	7	24	
^t PHL	A/B	Y	9	4	20	4	17	ns
^t PLH	G	V	14	7	25	7	20	ne
t _{PHL}	9	r	10	4	18	4	13	ns

[†] For conditions shown as MIN or MAX, use the appropriate value specified under recommended operating conditions.

switching characteristics (see Figure 1)

PARAMETER	FROM (INPUT)	то	$V_{CC} = 5 \text{ V},$ $C_L = 50 \text{ pF},$ $R_L = 500 \Omega,$ $T_A = 25^{\circ}\text{C}$	V_{CC} = 4.5 V to 5.5 V, C_L = 50 pF, R_L = 500 Ω , T_A = MIN to MAX \dagger				UNIT
	, ,		'ALS158	SN54ALS158		SN74AL	S158	
			TYP	MIN	MAX	MIN	MAX	
^t PLH	A D	V	9	4	18	4	15	ns
^t PHL	A or B	Y	5	2	12	2	8	
^t PLH	Ā/B		13	5	22	5	18	
t _{PHL}	A/B	Υ	13	5	22	5	18	ns
^t PLH	G	V	13	5	22	5	18	20
^t PHL	9	I	13	5	22	5	18	ns

[†] For conditions shown as MIN or MAX, use the appropriate value specified under recommended operating conditions.

SN54ALS157A, SN54ALS158 SN74ALS157A, SN74ALS158, SN74AS157, SN74AS158 QUAD 1-OF-2 DATA SELECTORS/MULTIPLEXERS

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absolute maximum ratings over operating free-air temperature range (unless otherwise noted)†

Supply voltage, V _{CC}	7 V
Input voltage, V ₁	7 V
Operating free-air temperature range, T _A : SN74AS157, SN74AS158	
Storage temperature range	

recommended operating conditions

		SN74AS157 SN74AS158			UNIT
		MIN	NOM	MAX	
VCC	Supply voltage	4.5	5	5.5	V
VIH	High-level input voltage	2			V
V_{IL}	Low-level input voltage			0.8	V
I _{OH}	High-level output current			-2	mA
lOL	Low-level output current			20	mA
TA	Operating free-air temperature	0		70	°C

electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

	PARAMETER	TEST COND	TEST CONDITIONS					
				MIN TYP‡	MAX			
VIK		V _{CC} = 4.5 V,	I _I = –18 mA		-1.2	V		
Vон		$V_{CC} = 4.5 \text{ V to } 5.5 \text{ V},$	$I_{OH} = -2 \text{ mA}$	V _{CC} -2		V		
VOL		V _{CC} = 4.5 V,	$I_{OL} = 20 \text{ mA}$	0.35	0.5	V		
	Ā/B	V 55V			0.2			
I ₁	A, B, or G	$V_{CC} = 5.5 \text{ V},$	V _I = 7 V		0.1	mA		
	Ā/B	.,,	.,,		40			
lн	A, B, or G	$V_{CC} = 5.5 V,$	$V_{I} = 2.7 V$		20	μΑ		
	Ā/B	.,			-1	mA		
ΊL	A, B, or \overline{G}	$V_{CC} = 5.5 V,$	$V_{I} = 0.4 V$		-0.5			
IO§	•	V _{CC} = 5.5 V,	V _O = 2.25 V	-30	-112	mA		
	SN74AS157	V 55V		17.5	28	A		
ICC	SN74AS158	V _{CC} = 5.5 V		15.6	22.5	mA		

[‡] All typical values are at $V_{CC} = 5 \text{ V}$, $T_A = 25^{\circ}\text{C}$.

[†] Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

[§] The output conditions have been chosen to produce a current that closely approximates one half of the true short-circuit output current, IOS.

switching characteristics (see Figure 1)

PARAMETER	FROM (INPUT)	TO (OUTPUT)	$V_{CC} = 4.5$ $C_{L} = 50 \text{ pF}$ $R_{L} = 500 \Omega$ $T_{A} = \text{MIN to}$ SN74A MIN	e, o MAX†	UNIT
t _{PLH}	A sur B	.,	1	6	
tPHL	A or B	Y	1	5.5	ns
^t PLH	- (D	V	2	11	
t _{PHL}	Ā/B	Y	2	10	ns
t _{PLH}	G		2	10.5	ne
t _{PHL}	g	ľ	2	7.5	ns

[†] For conditions shown as MIN or MAX, use the appropriate value specified under recommended operating conditions.

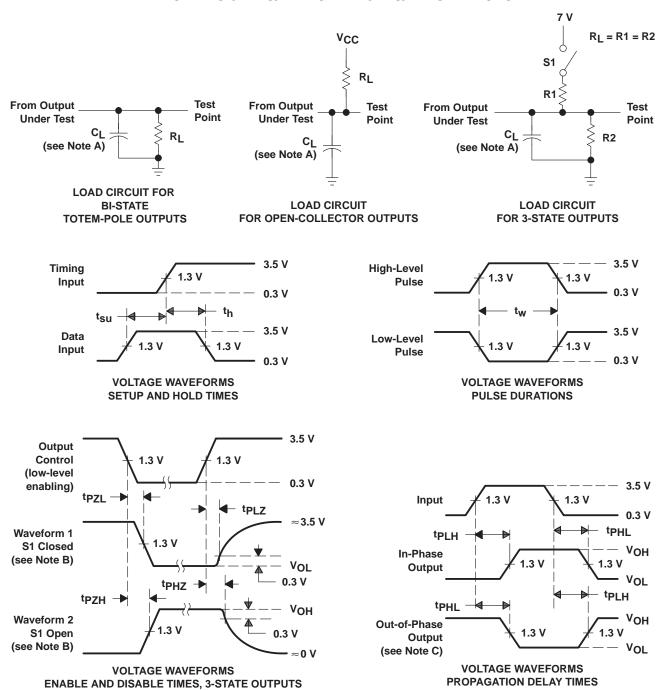
switching characteristics (see Figure 1)

PARAMETER	FROM (INPUT)	TO (OUTPUT)	V_{CC} = 4.5 \ C_L = 50 pF, RL = 500 Ω , TA = MIN to SN74AS	мах†	UNIT
t _{PLH}	. 5	.,	1	5	
t _{PHL}	A or B	Υ	1	4.5	ns
^t PLH	Ā/B	V	2	9.5	
^t PHL	A/B	Y	2	10.5	ns
^t PLH	G	v	2	6.5	ns
^t PHL	9	1	2	10	115

[†] For conditions shown as MIN or MAX, use the appropriate value specified under recommended operating conditions.

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PARAMETER MEASUREMENT INFORMATION SERIES 54ALS/74ALS AND 54AS/74AS DEVICES



NOTES: A. C_L includes probe and jig capacitance.

- B. Waveform 1 is for an output with internal conditions such that the output is low except when disabled by the output control. Waveform 2 is for an output with internal conditions such that the output is high except when disabled by the output control.
- C. When measuring propagation delay items of 3-state outputs, switch S1 is open.
- D. All input pulses have the following characteristics: PRR \leq 1 MHz, $t_{\Gamma} = t_{f} = 2$ ns, duty cycle = 50%.
- E. The outputs are measured one at a time with one transition per measurement.

Figure 1. Load Circuits and Voltage Waveforms







9-Mar-2021

PACKAGING INFORMATION

Orderable Device	Status (1)	Package Type	Package Drawing	Pins	Package Qty	Eco Plan (2)	Lead finish/ Ball material (6)	MSL Peak Temp	Op Temp (°C)	Device Marking (4/5)	Samples
5962-86869012A	ACTIVE	LCCC	FK	20	1	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	5962- 86869012A SNJ54ALS 157AFK	Samples
5962-8686901EA	ACTIVE	CDIP	J	16	1	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	5962-8686901EA SNJ54ALS157AJ	Samples
5962-8862501EA	ACTIVE	CDIP	J	16	1	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	5962-8862501EA SNJ54ALS158J	Samples
SN54ALS157AJ	ACTIVE	CDIP	J	16	1	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	SN54ALS157AJ	Samples
SN74ALS157AD	ACTIVE	SOIC	D	16	40	RoHS & Green	NIPDAU	Level-1-260C-UNLIM	0 to 70	ALS157A	Samples
SN74ALS157ADR	ACTIVE	SOIC	D	16	2500	RoHS & Green	NIPDAU	Level-1-260C-UNLIM	0 to 70	ALS157A	Samples
SN74ALS157AN	ACTIVE	PDIP	N	16	25	RoHS & Green	NIPDAU	N / A for Pkg Type	0 to 70	SN74ALS157AN	Samples
SN74ALS157ANSR	ACTIVE	SO	NS	16	2000	RoHS & Green	NIPDAU	Level-1-260C-UNLIM	0 to 70	ALS157A	Samples
SN74ALS158D	ACTIVE	SOIC	D	16	40	RoHS & Green	NIPDAU	Level-1-260C-UNLIM	0 to 70	ALS158	Samples
SN74ALS158N	ACTIVE	PDIP	N	16	25	RoHS & Green	NIPDAU	N / A for Pkg Type	0 to 70	SN74ALS158N	Samples
SN74ALS158NE4	ACTIVE	PDIP	N	16	25	RoHS & Green	NIPDAU	N / A for Pkg Type	0 to 70	SN74ALS158N	Samples
SN74ALS158NSR	ACTIVE	SO	NS	16	2000	RoHS & Green	NIPDAU	Level-1-260C-UNLIM	0 to 70	ALS158	Samples
SN74AS157D	ACTIVE	SOIC	D	16	40	RoHS & Green	NIPDAU	Level-1-260C-UNLIM	0 to 70	AS157	Samples
SN74AS157N	ACTIVE	PDIP	N	16	25	RoHS & Green	NIPDAU	N / A for Pkg Type	0 to 70	SN74AS157N	Samples
SN74AS158D	ACTIVE	SOIC	D	16	40	RoHS & Green	NIPDAU	Level-1-260C-UNLIM	0 to 70	AS158	Samples
SN74AS158N	ACTIVE	PDIP	N	16	25	RoHS & Green	NIPDAU	N / A for Pkg Type	0 to 70	SN74AS158N	Samples
SNJ54ALS157AFK	ACTIVE	LCCC	FK	20	1	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	5962- 86869012A SNJ54ALS 157AFK	Samples



PACKAGE OPTION ADDENDUM

9-Mar-2021

Orderable Device	Status (1)	Package Type	Package Drawing	Pins	Package Qty	Eco Plan	Lead finish/ Ball material	MSL Peak Temp	Op Temp (°C)	Device Marking (4/5)	Samples
SNJ54ALS157AJ	ACTIVE	CDIP	J	16	1	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	5962-8686901EA SNJ54ALS157AJ	Samples
SNJ54ALS158J	ACTIVE	CDIP	J	16	1	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	5962-8862501EA SNJ54ALS158J	Samples

(1) The marketing status values are defined as follows:

ACTIVE: Product device recommended for new designs.

LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

PREVIEW: Device has been announced but is not in production. Samples may or may not be available.

OBSOLETE: TI has discontinued the production of the device.

(2) RoHS: TI defines "RoHS" to mean semiconductor products that are compliant with the current EU RoHS requirements for all 10 RoHS substances, including the requirement that RoHS substance do not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, "RoHS" products are suitable for use in specified lead-free processes. TI may reference these types of products as "Pb-Free".

RoHS Exempt: TI defines "RoHS Exempt" to mean products that contain lead but are compliant with EU RoHS pursuant to a specific EU RoHS exemption.

Green: TI defines "Green" to mean the content of Chlorine (CI) and Bromine (Br) based flame retardants meet JS709B low halogen requirements of <=1000ppm threshold. Antimony trioxide based flame retardants must also meet the <=1000ppm threshold requirement.

- (3) MSL, Peak Temp. The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.
- (4) There may be additional marking, which relates to the logo, the lot trace code information, or the environmental category on the device.
- (5) Multiple Device Markings will be inside parentheses. Only one Device Marking contained in parentheses and separated by a "~" will appear on a device. If a line is indented then it is a continuation of the previous line and the two combined represent the entire Device Marking for that device.
- (6) Lead finish/Ball material Orderable Devices may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead finish/Ball material values may wrap to two lines if the finish value exceeds the maximum column width.

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PACKAGE OPTION ADDENDUM

9-Mar-2021

OTHER QUALIFIED VERSIONS OF SN54ALS157A, SN54ALS158, SN74ALS157A, SN74ALS158:

• Catalog: SN74ALS157A, SN74ALS158

Military: SN54ALS157A, SN54ALS158

NOTE: Qualified Version Definitions:

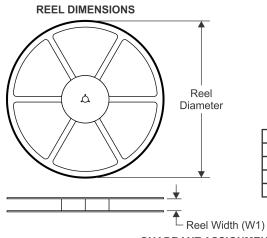
• Catalog - TI's standard catalog product

• Military - QML certified for Military and Defense Applications

PACKAGE MATERIALS INFORMATION

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TAPE AND REEL INFORMATION





	Dimension designed to accommodate the component width
B0	Dimension designed to accommodate the component length
K0	Dimension designed to accommodate the component thickness
W	Overall width of the carrier tape
P1	Pitch between successive cavity centers

QUADRANT ASSIGNMENTS FOR PIN 1 ORIENTATION IN TAPE



*All dimensions are nominal

Device Device	Package Type	Package Drawing		SPQ	Reel Diameter (mm)	Reel Width W1 (mm)	A0 (mm)	B0 (mm)	K0 (mm)	P1 (mm)	W (mm)	Pin1 Quadrant
SN74ALS157ADR	SOIC	D	16	2500	330.0	16.4	6.5	10.3	2.1	8.0	16.0	Q1
SN74ALS157ANSR	SO	NS	16	2000	330.0	16.4	8.2	10.5	2.5	12.0	16.0	Q1
SN74ALS158NSR	SO	NS	16	2000	330.0	16.4	8.2	10.5	2.5	12.0	16.0	Q1

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*All dimensions are nominal

	•							
Device	Package Type	Package Drawing	Pins SPQ		Length (mm)	Width (mm)	Height (mm)	
SN74ALS157ADR	SOIC	D	16	2500	333.2	345.9	28.6	
SN74ALS157ANSR	SO	NS	16	2000	853.0	449.0	35.0	
SN74ALS158NSR	SO	NS	16	2000	853.0	449.0	35.0	

FK (S-CQCC-N**)

LEADLESS CERAMIC CHIP CARRIER

28 TERMINAL SHOWN



- A. All linear dimensions are in inches (millimeters).
- B. This drawing is subject to change without notice.
- C. This package can be hermetically sealed with a metal lid.
- D. Falls within JEDEC MS-004



D (R-PDS0-G16)

PLASTIC SMALL OUTLINE



- A. All linear dimensions are in inches (millimeters).
- B. This drawing is subject to change without notice.
- Body length does not include mold flash, protrusions, or gate burrs. Mold flash, protrusions, or gate burrs shall not exceed 0.006 (0,15) each side.
- Body width does not include interlead flash. Interlead flash shall not exceed 0.017 (0,43) each side.
- E. Reference JEDEC MS-012 variation AC.



D (R-PDSO-G16)

PLASTIC SMALL OUTLINE



- A. All linear dimensions are in millimeters.
- B. This drawing is subject to change without notice.
- C. Publication IPC-7351 is recommended for alternate designs.
- D. Laser cutting apertures with trapezoidal walls and also rounding corners will offer better paste release. Customers should contact their board assembly site for stencil design recommendations. Refer to IPC-7525 for other stencil recommendations.
- E. Customers should contact their board fabrication site for solder mask tolerances between and around signal pads.



MECHANICAL DATA

NS (R-PDSO-G**)

14-PINS SHOWN

PLASTIC SMALL-OUTLINE PACKAGE



- A. All linear dimensions are in millimeters.
- B. This drawing is subject to change without notice.
- C. Body dimensions do not include mold flash or protrusion, not to exceed 0,15.



14 LEADS SHOWN



- A. All linear dimensions are in inches (millimeters).
- B. This drawing is subject to change without notice.
- C. This package is hermetically sealed with a ceramic lid using glass frit.
- D. Index point is provided on cap for terminal identification only on press ceramic glass frit seal only.
- E. Falls within MIL STD 1835 GDIP1-T14, GDIP1-T16, GDIP1-T18 and GDIP1-T20.

N (R-PDIP-T**)

PLASTIC DUAL-IN-LINE PACKAGE

16 PINS SHOWN



- A. All linear dimensions are in inches (millimeters).
- B. This drawing is subject to change without notice.
- Falls within JEDEC MS-001, except 18 and 20 pin minimum body length (Dim A).
- The 20 pin end lead shoulder width is a vendor option, either half or full width.



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